

CMOS 21-Stage Counter

High-Voltage Types (20-Volt Rating)

■ CD4045B is a timing circuit consisting of 21 counter stages, two output-shaping flip-flops, two inverter output drivers, and input inverters for use in a crystal oscillator. The CD4045B configuration provides 21 flip-flop counting stages, and two flip-flops for shaping the output waveform for a 3.125% duty cycle. Push-pull operation is provided by the inverter output drivers.

The first inverter is intended for use as a crystal oscillator/amplifier. However, it may be used as a normal logic inverter if desired. A crystal oscillator circuit can be made less sensitive to voltage-supply variations by the use of source resistors. In this device, the sources of the p and n transistors have been brought out to package terminals. If external resistors are not required, the sources must be shorted to their respective substrates (S_p to V_{DD} , S_n to V_{SS}). See Fig. 1. The first inverter in conjunction with an outboard inverter, such as 1/6 CD4069, and R_X , C_X , and R_S can also be used to construct an RC oscillator. The following data is supplied as a guide in the selection of values for R_X , R_S , and C_X used in Fig. 11:

1. R_X max = 10 M Ω with R_S = 10 M Ω and C_X = 50 pF
2. C_X max = 25 μ F with R_S = 560 k Ω and R_X = 50 k Ω

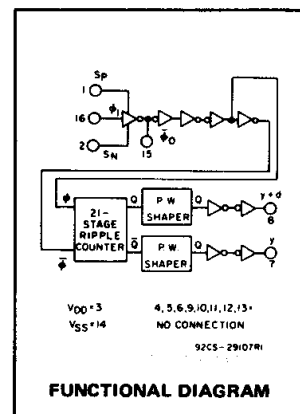
The CD4045B types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline package (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Applications:

- Digital equipment in which ultra-low dissipation and/or operation using a battery source is required.
- Accurate timing from a crystal oscillator for timing applications such as wall clocks, table clocks, automobile clocks, and digital timing references in any circuit requiring accurately timed outputs at various intervals in the counting sequence.
- Driving miniature synchronous motors, stepping motors, or external bipolar transistors in push-pull fashion.

Features:

- Very low operating dissipation <1 mW (typ.) @ V_{DD} = 5 V, $f\phi$ = 1 MHz
- Output drivers with sink or source capability 7 mA (typ.) @ V_{DD} = 5 V
- Medium speed (typ.) $f\phi$ = 25 MHz @ V_{DD} = 10 V
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, Standard Specifications for Description of 'B' Series CMOS Devices"



MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})	 -0.5V to +20V
Voltages referenced to V_{SS} Terminal	
INPUT VOLTAGE RANGE, ALL INPUTS	 -0.5V to V_{DD} + 0.5V
DC INPUT CURRENT, ANY ONE INPUT	 $\pm$ 10mA
POWER DISSIPATION PER PACKAGE (P_D):	
For T_A = -55°C to +100°C	 500mW
For T_A = +100°C to +125°C	 Derate Linearly at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	 100mW
OPERATING-TEMPERATURE RANGE (T_A)	 -55°C to +125°C
STORAGE TEMPERATURE RANGE (T_{stg})	 -85°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max	 +265°C

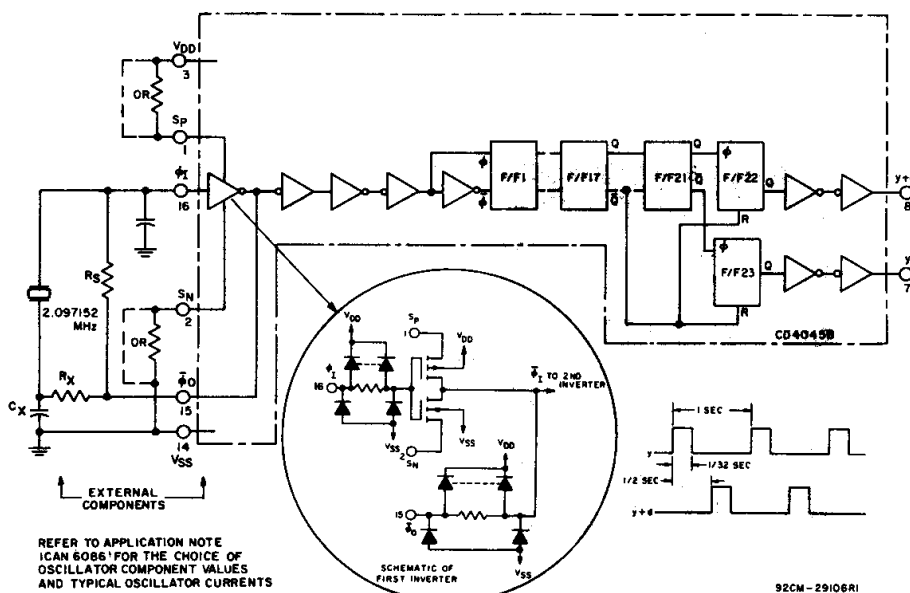


Fig. 1 – CD4045B and outboard components in a typical 21-stage counter application.

CD4045B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)	-55	-40	+85	+125	+25			
								Min.	Typ.	Max.	
Quiescent Device Current, I _{DD} Max.	—	0,5	5	5	5	150	150	—	0.04	5	μA
	—	0,10	10	10	10	300	300	—	0.04	10	
	—	0,15	15	20	20	600	600	—	0.04	20	
	—	0,20	20	100	100	3000	3000	—	0.08	100	
Output Low (Sink) Current I _{OL} Min.	0.4	0,5	5	4.5	4.3	2.9	2.5	3.6	7	—	mA
	0.5	0,10	10	11.2	10.5	7.7	6.3	9.1	18	—	
	1.5	0,15	15	29.4	28	19.6	16.8	23.8	47	—	
Output High (Source) Current, I _{OH} Min.	4.6	0,5	5	-4.5	-4.3	-2.9	-2.5	-3.6	-7	—	mA
	9.5	0,10	10	-11.2	-10.5	-7.7	-6.3	-9.1	-18	—	
	13.5	0,15	15	-29.4	-28	-19.6	-16.8	-23.8	-47	—	
Pin 15 Output Low and High Current, I _{OL} , I _{OH}	0.4,4.6	0,5	5	—				±0.1	±0.18	—	mA
	0.5,9.5	0,10	10	—				±0.2	±0.3	—	
	1.5,13.5	0,15	15	—				±0.5	±1	—	
Output Voltage: Low-Level, V _{OL} Max.	—	0,5	5	0.05				—	—	0.05	V
	—	0,10	10	0.05				—	—	0.05	
	—	0,15	15	0.05				—	—	0.05	
Output Voltage: High-Level, V _{OH} Min.	—	0,5	5	4.95				4.95	5	—	V
	—	0,10	10	9.95				9.95	10	—	
	—	0,15	15	14.95				14.95	15	—	
Input Low Voltage V _{IL} Max.	0.5,4.5	—	5	1.5				—	—	1.5	V
	1,9	—	10	3				—	—	3	
	1.5,13.5	—	15	4				—	—	4	
Input High Voltage, V _{IH} Min.	0.5,4.5	—	5	3.5				3.5	—	—	V
	1,9	—	10	7				7	—	—	
	1.5,13.5	—	15	11				11	—	—	
Input Current I _{IN} Max.	—	0,18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	μA

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges

CHARACTERISTIC	V _{DD} (V)	LIMITS		UNITS
		Min.	Max.	
Supply-Voltage Range (For T _A = Full Package-Temperature Range)	—	3	18	V
Minimum Input-Pulse Width, t _W	5	—	100	ns
	10	—	50	
	15	—	40	
Maximum Input-Pulse Frequency, f _{ϕ} (External Pulse Source)	5	5	—	MHz
	10	12	—	
	15	15	—	

CD4045B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$; Input $t_r, t_f = 20\text{ ns}$,
 $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS	V_{DD} V	LIMITS			UNITS
			Min.	Typ.	Max.	
Propagation Delay Time: ϕ_I to y or y+d out t_{PHL}, t_{PLH}		5 10 15	— — —	2.2 0.9 0.65	5.5 2.7 2	μs
Transition Time: t_{THL}, t_{TLH}		5 10 15	— — —	25 13 10	50 25 20	ns
Minimum Input-Pulse Width t_W		5 10 15	— — —	50 25 20	100 50 40	ns
Input-Pulse Rise or Fall Time: $t_r\phi, t_f\phi$		5 10 15	— — —	— — —	500 500 500	μs
Maximum Input-Pulse Frequency: (External Pulse Source) f_ϕ		5 10 15	5 12 15	10 25 30	— — —	MHz
Input Capacitance, C_{IN}	Any Input		—	5	7.5	pF
Variation of Output Frequency (Unit-to-Unit)	$f = 5\text{ MHz}$	5 10 15	— — —	0.05 0.03 0.1	— — —	%
RC Oscillator Operation						
Maximum Oscillator Frequency (See Fig. 11) f_{osc}	$R_X = 50\text{ k}\Omega$, $R_S = 560\text{ k}\Omega$, $C_X = 50\text{ pF}$	5 10 15	45 45 45	60 60 60	75 75 75	kHz

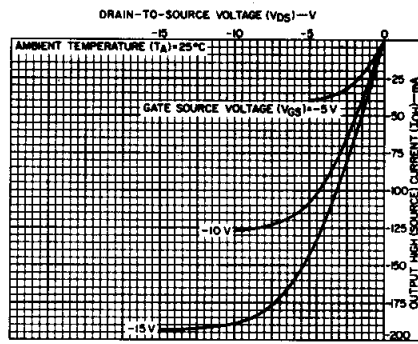


Fig. 4 - Typical output high (source) current characteristics.

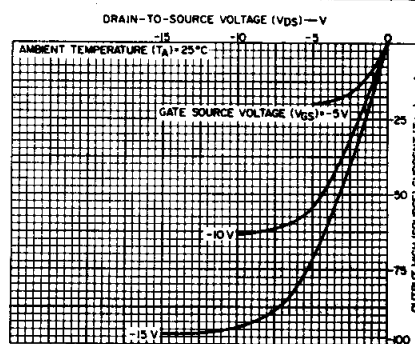


Fig. 5 - Minimum output high (source) current characteristics.

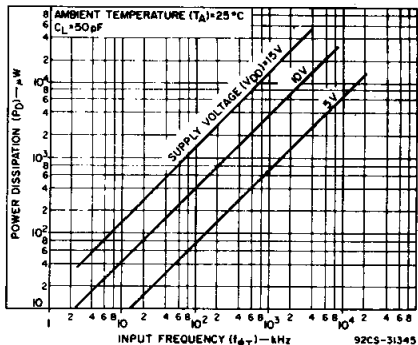


Fig. 7 - Typical power dissipation as a function of input frequency (21 counting stages).

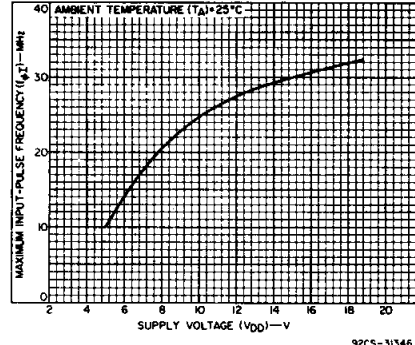


Fig. 8 - Typical maximum input-pulse frequency as a function of supply voltage.

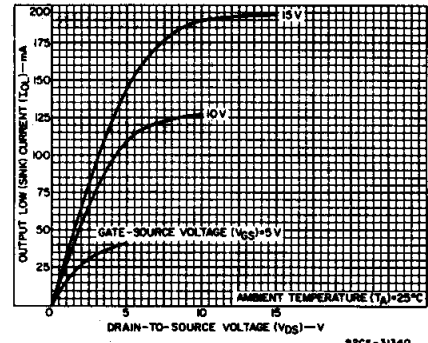


Fig. 2 - Typical output low (sink) current characteristics.

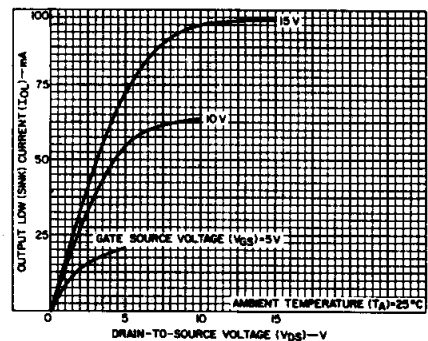


Fig. 3 - Minimum output low (sink) current characteristics.

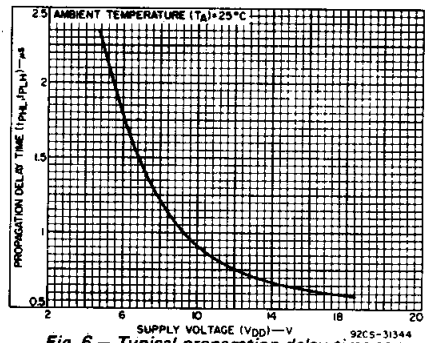


Fig. 6 - Typical propagation delay time as a function of supply voltage (ϕ_I to y or y + d out vs. V_{DD}).

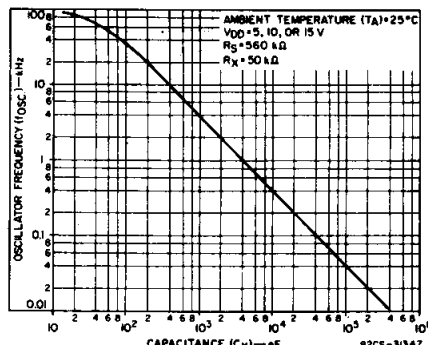


Fig. 9 - Typical RC oscillator frequency as a function of capacitance (C_X), See Fig. 11.

CD4045B Types

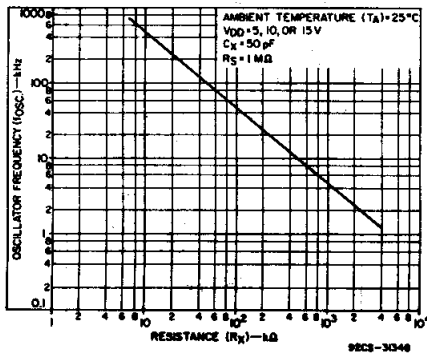


Fig. 10 - Typical RC oscillator frequency as a function of resistance (R_X). See Fig. 11.

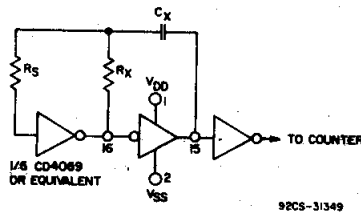


Fig. 11 - Typical RC circuit.

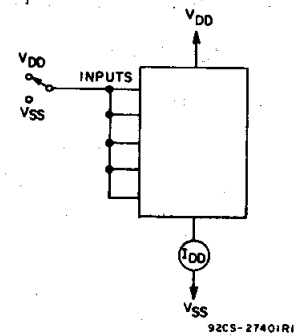


Fig. 12 - Quiescent-device-current test circuit.

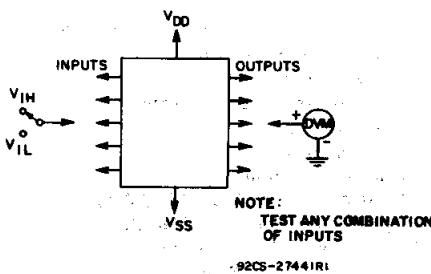


Fig. 13 - Noise-immunity test circuit.

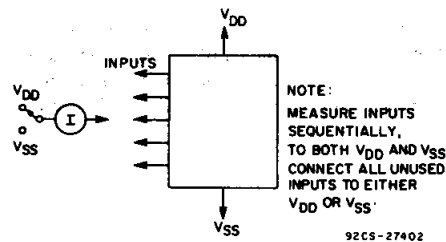


Fig. 14 - Input-leakage-current test circuit.

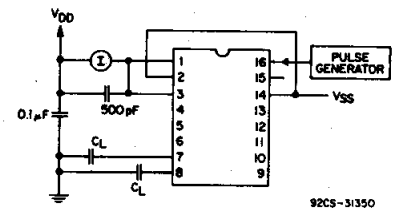
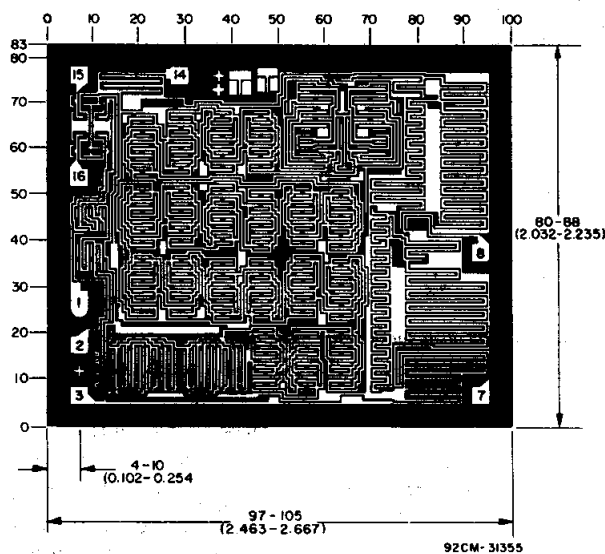


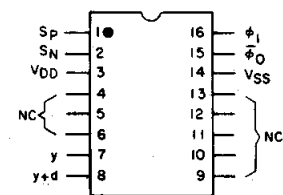
Fig. 15 - Dynamic power dissipation test circuit.



Chip dimensions and pad layout for CD4045B

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

TERMINAL DIAGRAM Top View



NC = NO CONNECTION

NOTE Observe power-supply terminal connections, V_{DD} is terminal No. 3 and V_{SS} is terminal No. 14 (not 16 and 8 respectively, as in other CD4000B Series 16-lead devices).

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
CD4045BE	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4045BE
CD4045BE.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4045BE

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TUBE



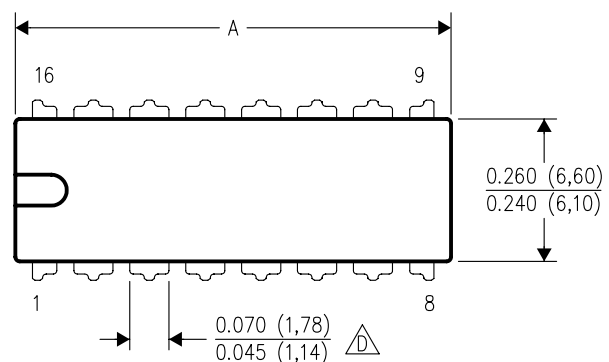
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
CD4045BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4045BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4045BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD4045BE.A	N	PDIP	16	25	506	13.97	11230	4.32

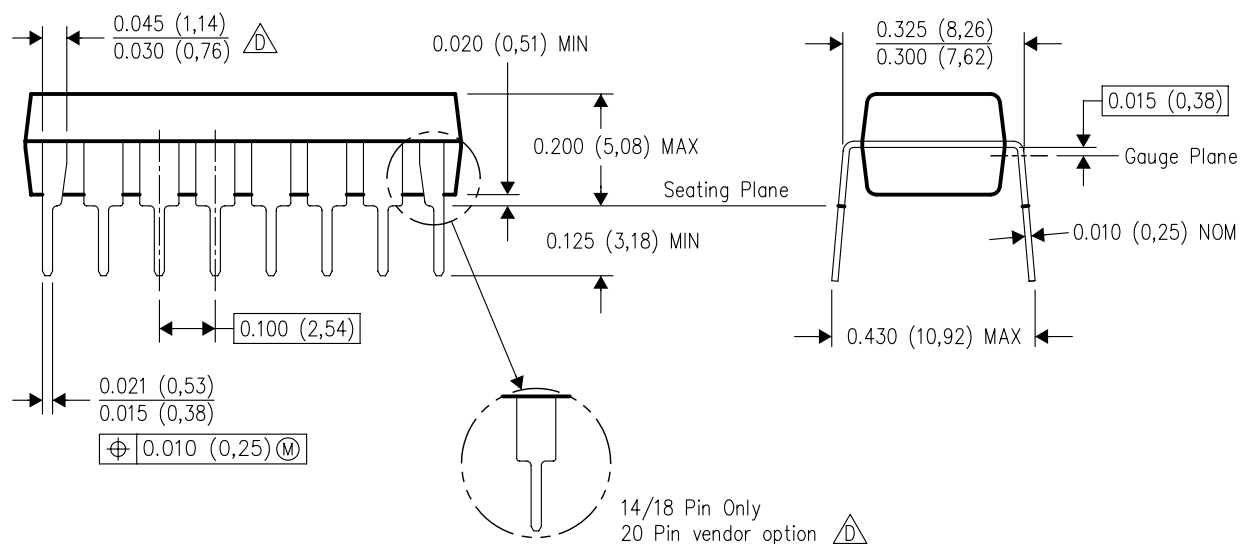
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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